

N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTOR

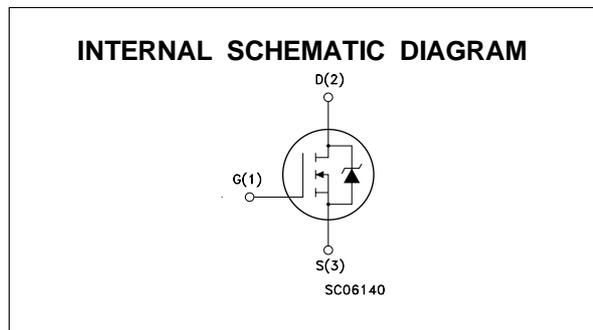
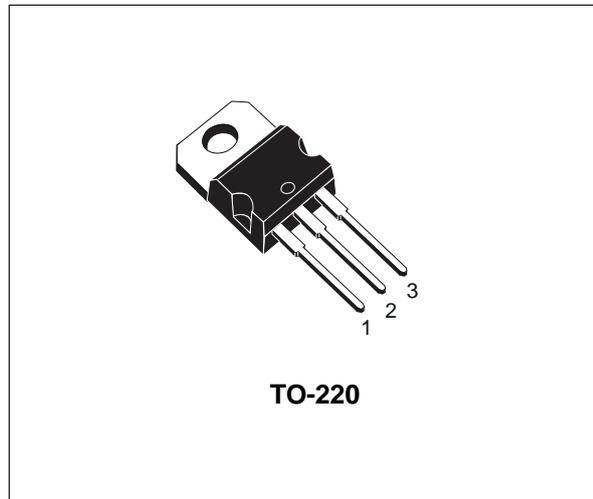
PRELIMINARY DATA

| TYPE | V _{DSS} | R _{DS(on)} | I _D |
|-------------|------------------|---------------------|----------------|
| STP60N05-14 | 50 V | < 0.014 Ω | 60 A |
| STP60N06-14 | 60 V | < 0.014 Ω | 60 A |

- TYPICAL R_{DS(on)} = 0.012 Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- 175 °C OPERATING TEMPERATURE
- VERY LOW R_{DS(on)}
- APPLICATION ORIENTED CHARACTERIZATION

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- REGULATORS
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, Etc.)



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | | Unit |
|---------------------|--|-------------|-------------|------|
| | | STP60N05-14 | STP60N06-14 | |
| V _{DS} | Drain-Source Voltage (V _{GS} = 0) | 50 | 60 | V |
| V _{DGR} | Drain-Gate Voltage (R _{GS} = 20 KΩ) | 50 | 60 | V |
| V _{GS} | Gate-Source Voltage | ± 20 | | V |
| I _D | Drain-Current (continuous) at T _c = 25°C | 60 | | A |
| I _D | Drain-Current (continuous) at T _c = 100°C | 50 | | A |
| I _{DM} (•) | Drain-Current (Pulsed) | 240 | | A |
| P _{tot} | Total Dissipation at T _c = 25°C | 150 | | W/°C |
| | Derating Factor | 1 | | °C |
| V _{ISO} | Insulation Withstand Voltage (DC) | - | | V |
| T _{stg} | Storage Temperature | -65 to 175 | | °C |
| T _j | Max Operating Junction Temperature | 175 | | °C |

(•)Pulse width limited by safe operating area

STP60N05-14/STP60N06-14

THERMAL DATA

| | | | | |
|-----------------------|--|-----|------|------|
| R _{thj-case} | Thermal Resistance Junction-case | Max | 1 | °C/W |
| R _{thj-amb} | Thermal Resistance Junction-ambient | Max | 62.5 | °C/W |
| R _{thj-amb} | Thermal Resistance Case-sink | Typ | 0.5 | °C/W |
| T _l | Maximum Lead Temperature For Soldering Purpose | | 300 | °C |

AVALANCHE CHARACTERISTICS

| Symbol | Parameter | Max Value | Unit |
|-----------------|--|-----------|------|
| I _{AR} | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T _j max, δ < 1%) | 60 | A |
| E _{AS} | Single Pulse Avalanche Energy (starting T _j = 25 °C, I _D = I _{AR} , V _{DD} = 25 V) | 600 | mJ |
| E _{AR} | Repetitive Avalanche Energy (pulse width limited by T _j max, δ < 1%) | 150 | mJ |
| I _{AR} | Avalanche Current, Repetitive or Not-Repetitive (T _c = 100 °C, pulse width limited by T _j max, δ < 1%) | 50 | A |

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------|---|--|------|------|-------------|----------|
| V _{(BR)DSS} | Drain-source Breakdown Voltage | I _D = 250 μA V _{GS} = 0 | 60 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V _{DS} = Max Rating V _{DS} = Max Rating x 0.8 T _c = 125 °C | | | 250 1000 | μA μA |
| I _{GSS} | Gate-body Leakage Current (V _{DS} = 0) | V _{GS} = ± 20 V | | | 100 | nA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|-----------------------------------|--|------|-------|----------------|--------|
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} I _D = 250 μA | 2 | 3 | 4 | V |
| R _{DS(on)} | Static Drain-source On Resistance | V _{GS} = 10 V I _D = 30 A V _{GS} = 10 V I _D = 30 A T _c = 100 °C | | 0.012 | 0.014 0.028 | Ω Ω |
| I _{D(on)} | On State Drain Current | V _{DS} > I _{D(on)} x R _{DS(on)max} V _{GS} = 10 V | 60 | | | A |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|------------------------------|---|------|------|------|------|
| g _{fs} (*) | Forward Transconductance | V _{DS} > I _{D(on)} x R _{DS(on)max} I _D = 30 A | 20 | 30 | | S |
| C _{iss} | Input Capacitance | V _{DS} = 25 V f = 1 MHz V _{GS} = 0 | | 3900 | 4800 | pF |
| C _{oss} | Output Capacitance | | | 950 | 1200 | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 250 | 320 | pF |

ELECTRICAL CHARACTERISTICS (continued)**SWITCHING ON**

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------|--|---|------|-----------------|-----------|------------------|
| $t_{d(on)}$ t_r | Turn-on Time Rise Time | $V_{DD} = 25\text{ V}$ $R_G = 4.7\ \Omega$ | | 30 180 | 50 250 | ns ns |
| $(di/dt)_{on}$ | Turn-on Current Slope | $V_{DD} = 40\text{ V}$ $R_G = 47\ \Omega$ | | 210 | | A/ μs |
| Q_g Q_{gs} Q_{gd} | Total Gate Charge Gate-Source Charge Gate-Drain Charge | $V_{DD} = 40\text{ V}$ $I_D = 60\text{ A}$ $V_{GS} = 10\text{ V}$ | | 130 26 55 | 170 | nC nC nC |

SWITCHING OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------------------|---|---|------|------------------|------------------|----------------|
| $t_{r(Voff)}$ t_f t_c | Off-voltage Rise Time Fall Time Cross-over Time | $V_{DD} = 40\text{ V}$ $R_G = 4.7\ \Omega$ | | 35 135 180 | 50 190 250 | ns ns ns |

SOURCE DRAIN DIODE

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-----------------------------------|---|--|------|------------------|-----------|--------------------------|
| I_{SD} $I_{SDM}(\bullet)$ | Source-drain Current Source-drain Current (pulsed) | | | | 60 240 | A A |
| $V_{SD} (*)$ | Forward On Voltage | $I_{SD} = 60\text{ A}$ $V_{GS} = 0$ | | | 1.6 | V |
| t_{rr} Q_{rr} I_{RRM} | Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current | $I_{SD} = 60\text{ A}$ $V_{DD} = 30\text{ V}$ | | 150 0.56 9 | | ns μC A |

(*) Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %

(\bullet) Pulse width limited by safe operating area